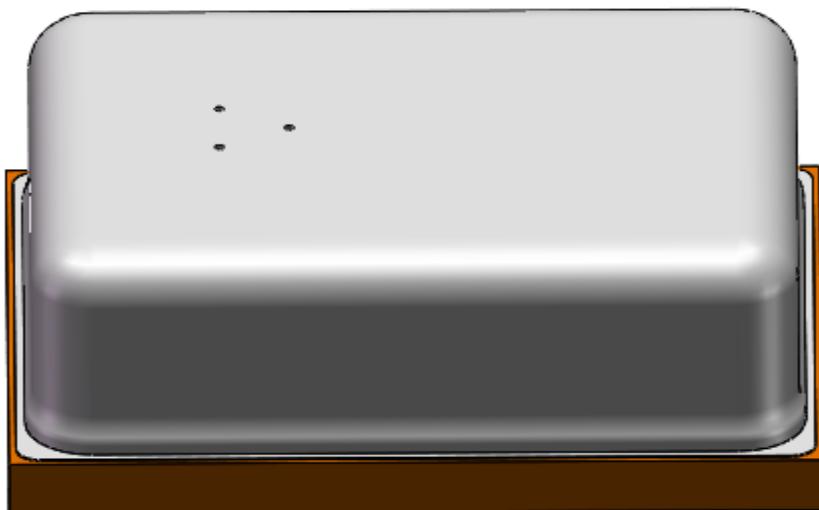


# SV01-003

## Bone Sensor

Product Datasheet



# Restricted

## 1. Security warning

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## 2. Publication history

| Version | Date       | Description                                  |
|---------|------------|--|
| 1.0     | 2021.08.31 | Preliminary datasheet                        |
| 1.1     | 2021.09.23 | Update tape depth in package specifications  |
| 2.0     | 2021.10.21 | Update response curve and mark configuration |
| 3.0     | 2021.12.23 | Update response curve                        |
|         |            |  |
|         |            |  |
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## 1. Introduction

The SV01-003 is a high performance Bone sensor optimized for picking-up people's voice through bone vibration, which achieves a better signal with high SNR and shields the normal ambient sound noise.

### Key features

- Package: 6-pin LGA package, 3.5mm x 2.65mm x 1.30mm
- Pb-free, halogen-free and RoHS compliant

### Performance

- Supply voltage: 1.52 ... 1.89V (low power mode)
- Low Current: 50 µA
- High sensitivity: -25 +3/-2 dBv/g
- Low Noise: Noise Density <2ug/vHz
- Reflow Solderable

### Applications

- Wearable/hearable devices
- Communication in noisy/challenging types of environments
- Hearing aids
- Bone Joint Monitor in health prediction field
- Mechanical Joint Monitor and device conditioning
- Structure Health Monitor

## 2. Absolute Maximum Ratings

Table 1: Absolute Maximum Ratings

| Parameters           | Condition             | Min  | Max   | Unit |
|----------------------|-----------------------|------|-------|------|
| Storage Temperature  |                       | -40  | +85   | °C   |
| Supply Voltage       | All Pins              | -0.3 | +3.6  | V    |
| ESD rating           | HBM,R=1.5kohm,C=100pF |      | ±2    | kV   |
| Maximum Acceleration | in Z Direction        |      | 10000 | g    |

### 3. Testing Conditions

Table 2: Testing Condition (Vent Hole Sealed)

| Test Conditions     | Temperature | Humidity    | Air Pressure   |
|---------------------|-------------|-------------|----------------|
| Standard Conditions | +15~+35°C   | 25%RH~75%RH | 860hPa~1060hPa |
| Judgment Conditions | +20±2°C     | 40%RH~50%RH | 860hPa~1060hPa |

### 4. Characteristics

Table 3: Parameter List

| Parameters                | Symbol | Condition                                    | Min  | Typical | Max  | Unit   |
|---------------------------|--------|--|------|---------|------|--------|
| <b>Power Supply</b>       |        |  |      |         |      |        |
| Supply Voltage            | Vdd    | Low Power Mode                               | 1.52 | 1.8     | 1.89 | V      |
|                           |        | Normal Mode                                  | 2.3  |         | 3.0  | V      |
| Current                   | IDD    | 1.52V≤VDD≤1.89V                              |      | 50      | 100  | uA     |
|                           |        | 2.3V≤VDD≤3.0V                                |      | 150     | 200  | uA     |
| Output Impedance          | Zout   |  |      | 150     | 400  | Ω      |
| <b>Performance</b>        |        |  |      |         |      |        |
| Sensitivity               | S      | f=100Hz, Z Axis, re.1kHz value               | -8   | -5      | -2   | dBV/g  |
|                           |        | f=1000Hz, Z Axis                             | -27  | -25     | -22  | dBV/g  |
|                           |        | f=2000Hz, Z Axis, re.1kHz value              | -1   | 2       | 5    | dBV/g  |
| Acoustic Sensitivity Loss | @100Hz | Sensitivity loss to ambient acoustic signals | 40   | 50      |      | dB     |
|                           | @1kHz  |  | 30   | 40      |      | dB     |
| Acceleration Level        |        | <10% THD@1kHz                                |      | ±4      |      | g      |
| <b>Low Power Mode</b>     |        |  |      |         |      |        |
| Equivalent Noise          |        | BW=100~4000Hz, A-weighted1/3 octave          |      | -101    |      | dBv    |
| Noise Density             | @250Hz |  |      |         | 6    | ug/vHz |
|                           | @1kHz  |  |      |         | 3    | ug/vHz |
|                           | @2kHz  |  |      |         | 2    | ug/vHz |
| <b>Normal Mode</b>        |        |  |      |         |      |        |
| Equivalent Noise          |        | BW=100~4000Hz, A-weighted1/3 octave          |      | -102    |      | dBv    |
| Noise Density             | @250Hz |  |      |         | 6    | ug/vHz |
|                           | @1kHz  |  |      |         | 3    | ug/vHz |
|                           | @2kHz  |  |      |         | 2    | ug/vHz |

Response Curve:

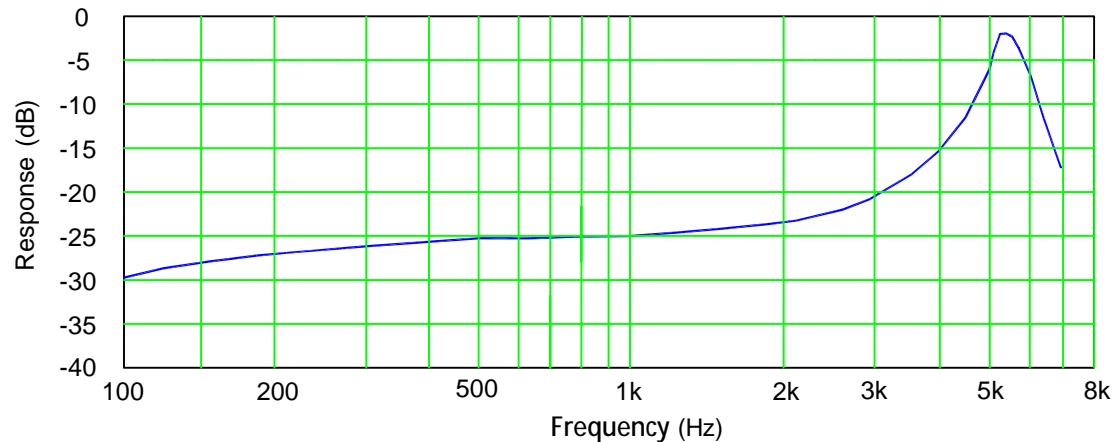


Figure 1: Frequency Response Curve

## 5. Mechanical Parameters

### 5.1 Pin Configuration

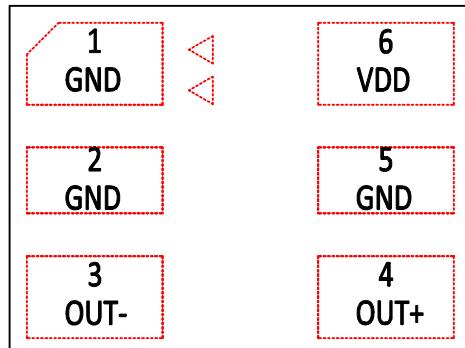


Figure 2: Layout pin configuration SV01-003  
(Top View, PAD not visible)

Table 4: SV01-003 Pin Configuration

| Pin | Name | Function      |
|-----|------|---------------|
| 1   | GND  | Ground        |
| 2   | GND  | Ground        |
| 3   | OUT- | Signal Output |
| 4   | OUT+ | Signal Output |
| 5   | GND  | Ground        |
| 6   | VDD  | Power Supply  |

## 5.2 Outline Dimensions

The sensor housing is a 6 Pin LGA package with metal lid. Its dimensions are 3.5mm ( $\pm 0.1$  mm) x 2.65mm ( $\pm 0.1$  mm) x 1.3mm ( $\pm 0.1$ mm). Tolerance is  $\pm 0.1$ mm unless otherwise specified.

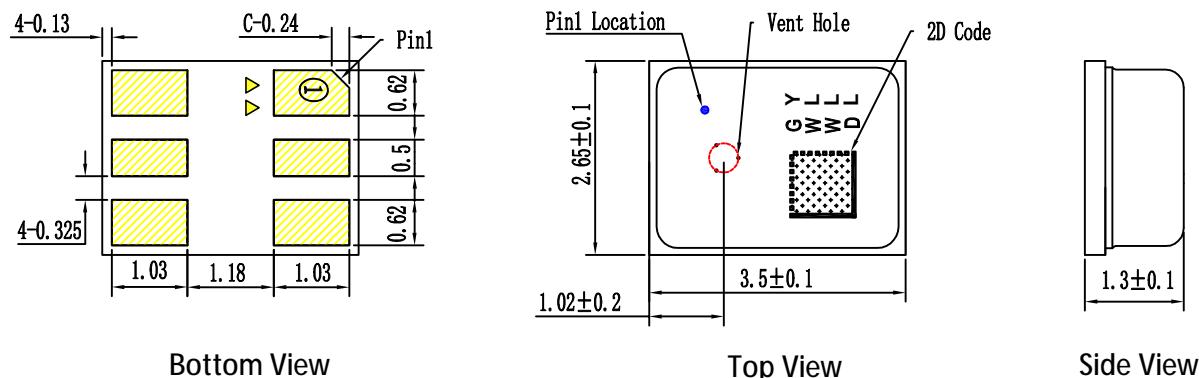


Figure 3: SV01-003 outline and size

## 6. Storage and Transportation

Keep in warehouse with less than 75% humidity and without sudden temperature change, acid air, any other harmful air or strong magnetic field.

The sensor with normal pack can be transported by ordinary conveyances. Please protect products against moist, shock, sunburn and pressure during transportation.

Storage Temperature Range: -40°C ~ +85°C

Operating Temperature Range: -30°C ~ +70°C

## 7. Cautions

### Vent Hole Protection

During reflow welding, it is forbidden to seal the vent holes of the sensor, to let air flow through vent holes in high temperature and avoid high air expansion damaging the package and the sensor.

After reflow process, it is recommended to seal the vent holes with Mylar membrane or UV glue, to prevent particle and enhance acoustic sensitivity loss.

After vent holes sealed, it is not recommended to handle the sensor in high temperature (more than 100°C), to avoid air expansion and damage to sensor and its performance.

### Nozzle Application

During SMT process, pay attention to avoid picking vent holes area, otherwise this may cause the device damage.

### Others

It is forbidden to wash the device with liquid before sealed hole, such as water, alcohol etc., otherwise this could damage the device.

## 8. PCB Design and Reflow Soldering

### Land Pattern Recommendation

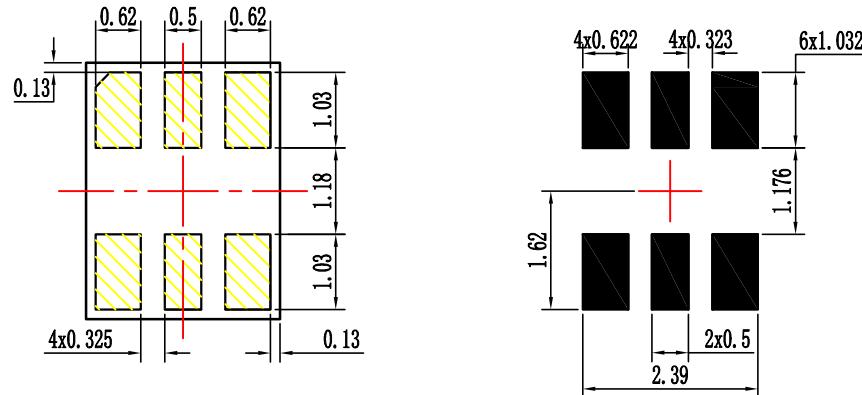


Figure 4: PCB Layout Pattern (Left), Solder Paste Stencil Pattern (Right)

### Nozzle and Picking Area

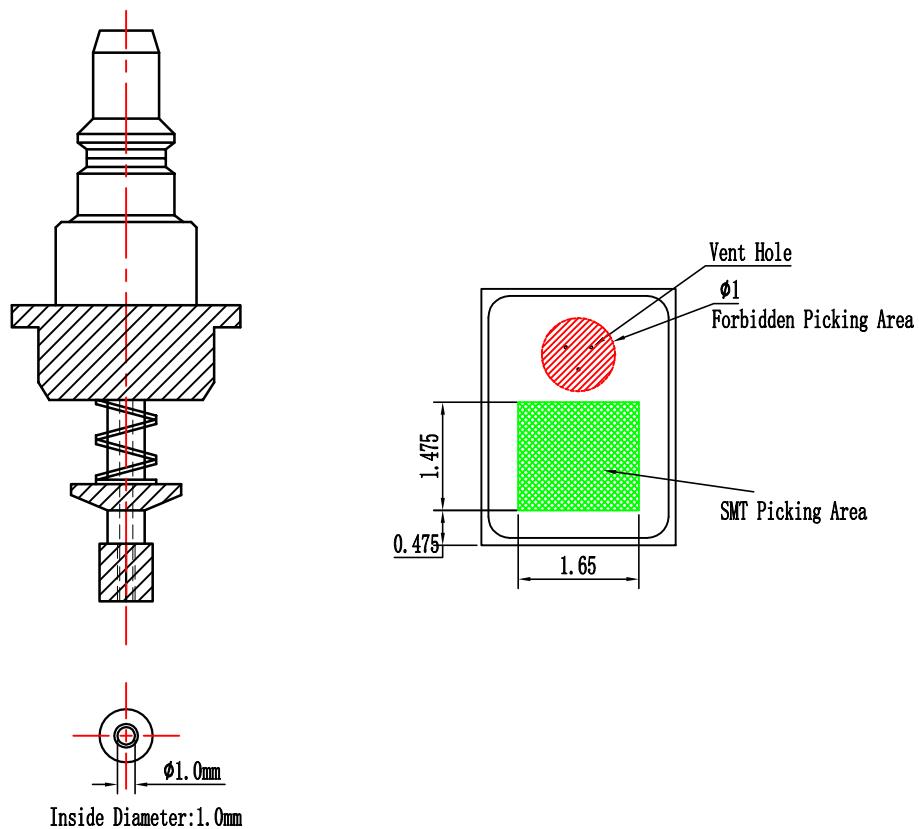


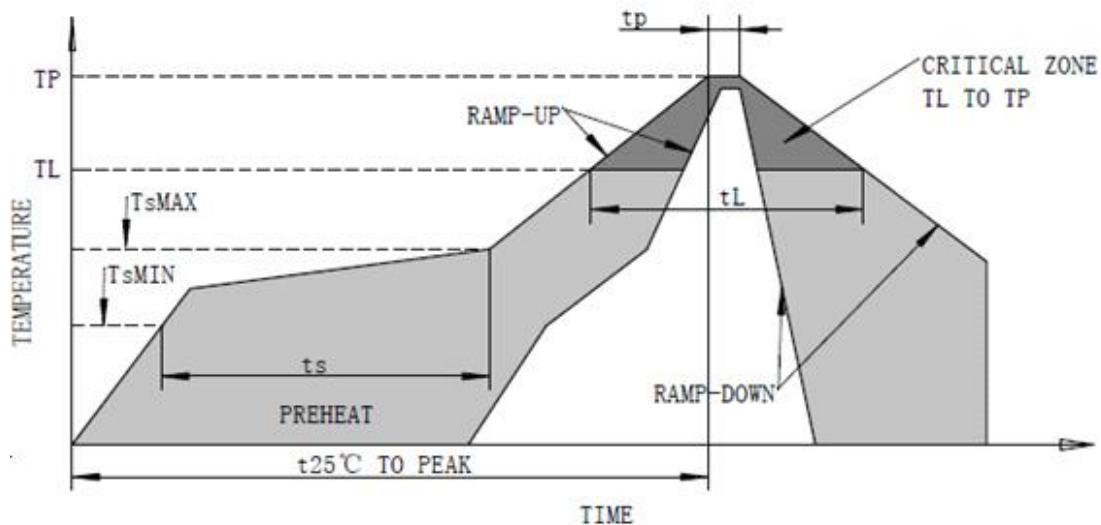
Figure 5: SMT Nozzle Dimension (Left), Picking Area Drawing (Right)

## Soldering Recommendation

## Soldering Machine Condition

|                     |           |
|---------------------|-----------|
| Temperature Control | 8 zones   |
| Heater Type         | Hot Air   |
| Solder Type         | Lead-free |

## Soldering Profile



| Profile Feature                                 | Pb-Free Assembly   |
|---|--------------------|
| Average ramp-up rate(TsMAX to TP)               | 2.5°C/seconds max. |
| Preheat   |                    |
| -Temperature Min.(TsMIN)                        | 150°C              |
| -Temperature Max.(TsMAX)                        | 200°C              |
| -Time(TsMIN to TsMAX)(ts)                       | 120~180 seconds    |
| Time maintained above:                          |                    |
| -Temperature(tL)                                | 217°C              |
| -Time(tL)                                       | Max 80 seconds     |
| Peak temperature(TP)                            | 260°C              |
| Time within 5°C of actual peak temperature(TP)2 | Max 50 seconds     |
| Ramp-down rate                                  | -5°C/seconds max.  |
| Time 25°C to peak temperature                   | 8 minutes max.     |

## 9. Package Specifications

### 9.1 Tape Specifications

Quantity per reel: 4000pcs.

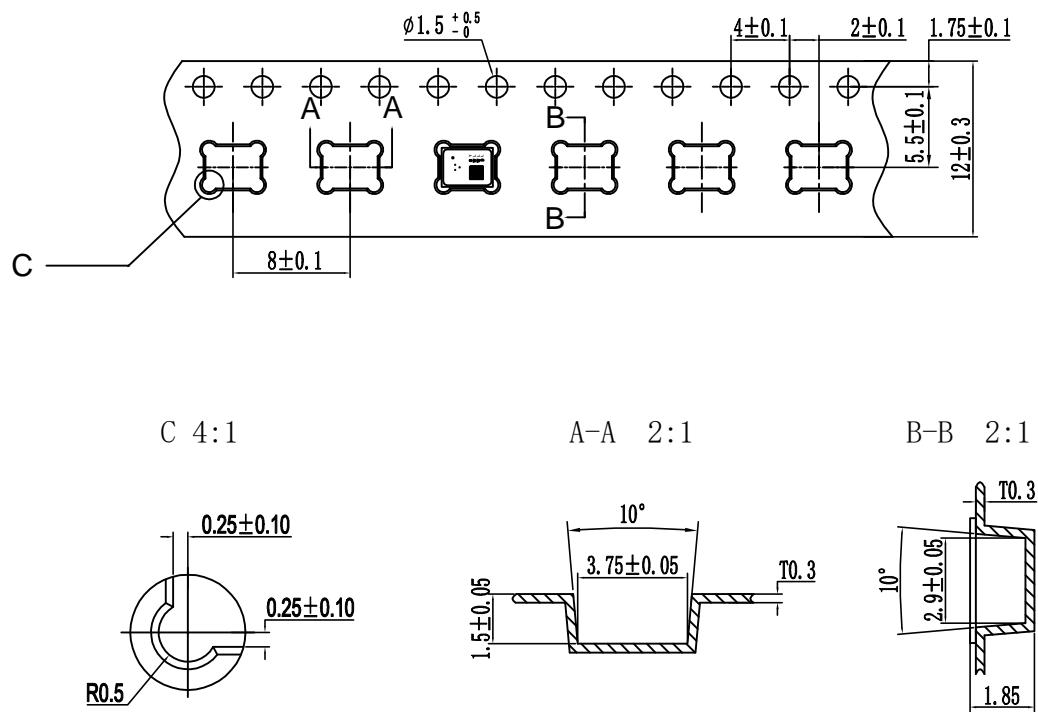


Figure 6: Tape Information (Unit: mm)

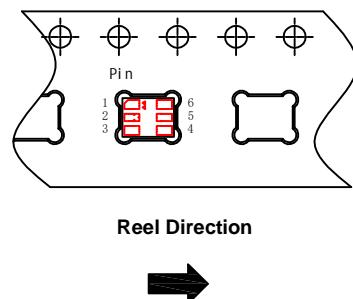
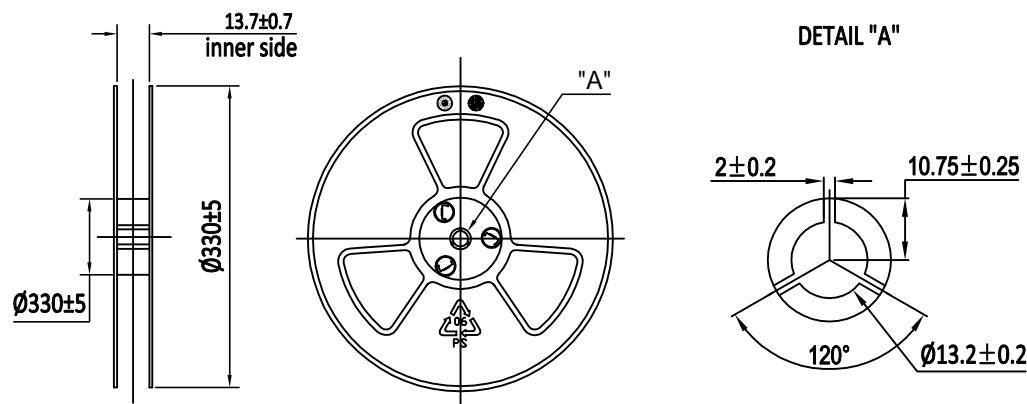


Figure 7: Pin Information

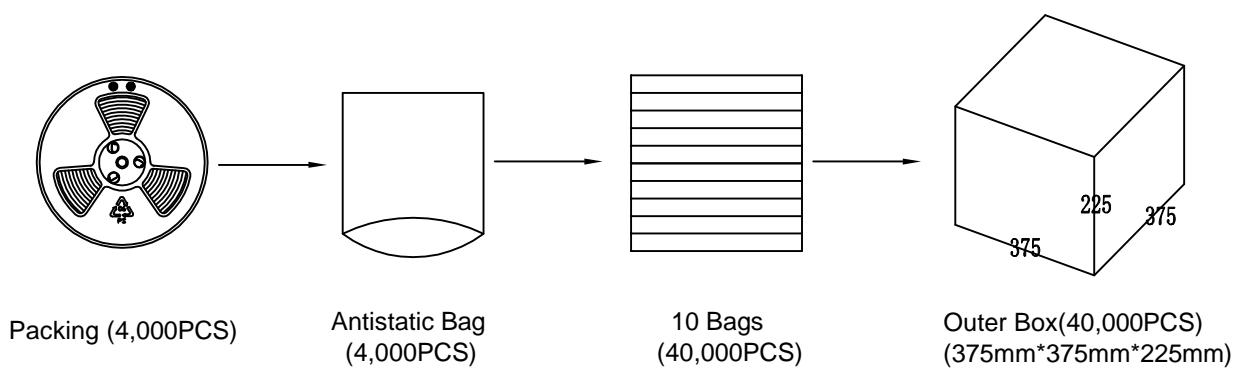
## 9.2 Reel Specification

13" reel will be provided for mass production stage and sample stage more than 1000pcs

13" Reel Specification (Unit: mm)

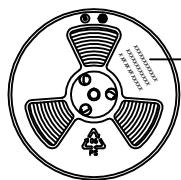


## 9.3 The content of Box



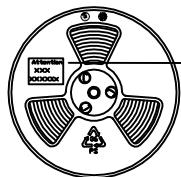
## 9.4 Packing Explain

### The Label Content of the Reel



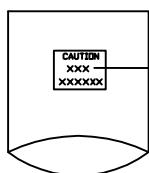
The Content Includes:  
RoHS+HF, MSL: ;  
Product type, Lot, Customer P/N;  
and other essential information such as  
Quantity, Date etc.

### The Label Content of ESD Caution



ESD Caution Label

### The Label Content of Moisture Caution



MSL 1 Caution Label